PRATING	APPL	ICAE	BLE STANI	DARD									
RATING	OPERATIN				55 °C TO 95					<u></u>	10°C TO 60°	C (2)	
CURRENT     0.5 A (SIGNAL CONTACT)     SPECIFICATIONS											-10 °C TO 60 °		
CURRENT	RAT	ING							CHUMIDIT	.	40 % TO 70	<b>%</b> <sup>(2)</sup>	
ITEM TEST METHOD REQUIREMENTS QT  CONSTRUCTION  SENERAL EXAMINATION (ISUALLY AND BY MEASURING INSTRUMENT.  SENERAL EXAMINATION (ISUALLY AND BY MEASURING INSTRUMENT.  SENERAL EXAMINATION (ISUALLY AND BY MEASURING INSTRUMENT.  SELECTRIC CHARACTERISTICS  CONTACT RESISTANCE  LOOTING TO RESISTANCE  SOUTH THE SISTANCE STANDE  SOUTH THE SISTANDE  SOUTH THE SISTANCE STANDE  SOUTH THE SISTANCE STANDE  SOUTH THE SISTANCE STANDE  SOUTH THE SISTANCE STANDE  SOUTH THE SISTANDE STANDE  SOUTH THE SISTANCE STANDE  SOUTH THE SISTANCE STANDE STANDE  SOUTH THE SISTANCE STANDE  SOUTH THE SISTANCE STANDE  SOUTH THE SISTANCE STANDE  SOUTH THE SISTANCE STANDE  SOUTH THE SISTANDE STANDES ST			CURRENT		0.5 A (SIGNAL CONT.	0.5 A (SIGNAL CONTACT) (3)					RELATIVE HUMIDITY		max
TIEM TEST METHOD REQUIREMENTS QT  CONSTRUCTION  SENERAL EXAMINATION   VISUALLY AND BY MEASURING INSTRUMENT.   ACCORDING TO DRAWING.   x  KARKING   CONFIRMED VISUALLY   x  ELECTRIC CHARACTERISTICS  CONTACT FESISTANCE   100 mA(DC OR 1000Hz)   SIGNAL CONTACT   90 mQ MAX.   x  MECHANICAL CHARACTERISTICS  NISUALATION RESISTANCE   250 V.D.   1000 M Q MIN   x  VOLTAGE PROOF   30 V.D.   1000 M Q MIN   x  VOLTAGE PROOF   30 V.D.   1000 M Q MIN   x  WECHANICAL CHARACTERISTICS  NEERTION AND   MEASURED BY APPLICABLE CONNECTOR   WITHDRAWAL FORCE   80 N MAX.   x  WITHDRAWAL FORCES   WITHDRAWAL FORCE   80 N MAX.   x  WITHDRAWAL FORCE   80 N MIN.   x  WITHORAWAL FORCE   80 N MIN.   x  WITHDRAWAL FORCE   80 N MIN.   x  WITHDRAW									, , ,				
CONSTRUCTION    ACCORDING TO DRAWING.   X					SPEC	IFICA	4OITA	NS					
SEMERAL EXAMINATION INSUALLY AND BY MEASURING INSTRUMENT.  CONTROL PRINTED VISUALLY.  ELECTRIC CHARACTERISTICS  TONTROL RESISTANCE  100 ma/DC OR 1000Hz)  SIGNAL CONTACT: 90 m2 MAX.  **  **  **  **  **  **  **  **  **					TEST METHOD				REC	QUIF	REMENTS	QT	Α
MARKING													
ELECTRIC CHARACTERISTICS  CONTACT RESISTANCE  100 ma(DC OR 1000Hz)  100 ma(DMM)			(AMINATION			STRUME	NT.	ACCOF	RDING TO	DR/	AWING.		×
CONTACT RESISTANCE    100 mA(DC OR 1000Hz)			CHADAC										<u> </u>
MF CONTACT   30 m Q MAX								SIGNA	LCONTAC	CT	90 m Q MAX	Ι×	Ι_
VOLTAGE PROOF 300 V AC FOR 1 min. NO FLASHOVER OR BREAKDOWN. X  MECHANICAL CHARACTERISTICS  INSERTION AND MEASURED BY APPLICABLE CONNECTOR. INSERTION FORCE: 80 N MAX. WITHDRAWAL FORCES  MECHANICAL CONTACT: 100 mc MAX. WITHDRAWAL FORCE: 8 N MIN. X  WITHDRAWAL FORCES  MECHANICAL CONTACT: 100 mc MAX. WITHDRAWAL FORCE: 8 N MIN. X  WITHDRAWAL FORCES  SIGNAL CONTACT: 100 mc MAX. 2 NO DAMAGE. CRACK AND LOOSENESS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTIONS OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SIGNAL CONTACT: 100 mc MAX. AND EXECUTION OF PARTS. SI													
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MITHDRAWAL FORCES  MICHANICAL  OPERATION  SOO TIMES INSERTIONS AND EXTRACTIONS.  SOO TACT RESISTANCE: SIGNAL CONTACT: 100 m Ω MAX. MF CONTACT: 40 m Ω MAX. MF CONTACT: 100 m Ω MAX. MF CONT								1					
MECHANICAL OPERATION   S00 TIMES INSERTIONS AND EXTRACTIONS.   (1) CONTACT RESISTANCE: SIGNAL CONTACT : 100 m Q MAX. MF CONTACT : 100 m Q MAX. MF CONTACT : 40 m Q MAX. MF				MEASURED BY APPLICABLE CONNECTOR.				I				×	-
MF CONTACT : 40 m Ω MAX. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.  SINGLE AMPLITUDE : 0.75 mm, 10 CYCLES FOR 3 DIRECTIONS.  SHOCK  490 m/s², DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.  SENVIRONMENTAL CHARACTERISTICS DAMP HEAT (STEADY STATE)  EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h. (STEADY STATE)  EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h. (INDER 5 CYCLES. (RELOCATION TIME TO CHAMBER-WITHIN 2~3 MIN)  UNDER 5 CYCLES. (RELOCATION TIME TO CHAMBER-WITHIN 2~3 MIN)  SULFUR DIOXIDE  EXPOSED AT 25±2 °C, 75±5 %RH, 25 PPM FOR 96 h. (TEST STANDARD: JIS C 60068)  RESISTANCE TO SOLDERING HEAT  PEAK TMP: 260°CMAX REFLOW SOLDERING: PEAK TMP: 260°CMAX REFLOW TMP: 220°CMIN FOR 60sec 2) SOLDERING RIONS: 380°C MAX FOR 5 sec.  SOLDERABILITY  COUNT  DESCRIPTION OF REVISIONS  DESIGNED  COUNT  DESCRIPTION OF REVISIONS  DESIGNED  AND DEFORMATION OF CASE OF EXEMPLIANT OF CO.  AND DEFORMATION OF ASE OF TERMINAL.  AND DEFORMATION OF ASE OF TERMINAL  AND DEFORMATION OF SOLDER  **ERMARKS*** "INCLUDE TEMPERATURE RISE CAUSED BY CURRENT CARRYING.  **COUNT DESCRIPTION OF REVISIONS  DESIGNED  COUNT DESCRIPTION OF REVISIONS  DESIGNED  COUNT DESCRIPTION OF REVISIONS  DESIGNED  CHECKED  A PAPPOVED  H. SAND  11.0  CHECKED  A PAPPOVED  H. SAND  11.0  CHECKED  KI. HIRDKMM  11.0  DRAWN  TH. SAND  11.0  DRAWN  TH. SAND  11.0  DRAWN  TH. SAND  11.0  FX18-140P-0. 8SH  HIROSE ELECTRIC CO., LTD.  CODE NO.  CL579-0007-9-00   L.   HIROSE  CLECTRICAL AND LOOSENESS  OF PARTS.  **X  **X  **X  **NO DAMAGE, CRACK AND LOOSENESS  OF PARTS.  **SIGNAL CONTACT : 40 m \( \text{ MM}\) MX.  **X  **SIGNAL CONTACT : 40 m \( \text{ MM}\) MX.  **X  **SIGNAL CONTACT : 40 m \( \text{ MM}\)  **NO DAMAGE, CRACK AND LOOSENESS  OF PARTS.  **NO DEFORMATION OF CASE OF  **ENDING TO CRACK AND LOOSENESS  OF PARTS.  **NO DEFORMATION OF CASE OF  **ENDING TO CRACK AND LOOSENESS  OF PARTS.  **A NEW UNIFORM COATING OF  **CHECKED  **A NEW UNIFORM COATING				500 TIMES INSERTIONS AND EXTRACTIONS.			NS.					×	+-
C. NO DAMAGE, CRACK AND LOOSENESS OF PARTS.								10	SIGNAL CONTACT : 100 m Ω MAX.				
VIBRATION													
SPECUENCY 10 TO 56 TO 10Hz, APPROX 5min SINGLE AMPLITUDE: 0.75 mm, 10 CYCLES FOR 3 DIRECTIONS.									· ·				
SINGLE AMPLITUDE: 0.75 mm, 10 CYCLES FOR 3 DIRECTIONS.  SHOCK  490 m/s², DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.  ENVIRONMENTAL CHARACTERISTICS  DAMP HEAT (STEADY STATE)  EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.  (STEADY STATE)  TIME 30 → 30 min.  UNDER 5 CYCLES.  (RELOCATION TIME TO CHAMBER: WITHIN 2~3 MIN)  (RELOCATION TIME TO CHAMBER: WITHIN 2~3 MIN)  (RELOCATION TIME TO CHAMBER: WITHIN 2~3 MIN)  SULFUR DIOXIDE  EXPOSED AT 25±2 °C, 75±5%RH, 25 PPM FOR 96 h.  (TEST STANDARD: JIS C 60068)  RESISTANCE TO  1) PREFLOW SOLDERING:  SOLDERING HEAT  PEAK TMP: 280°CMAX  REFLOW TIMP: 220°CMIN FOR 60sec 2) SOLDERING RIONS: 300°C MAX. FOR 5 sec.  SOLDERING RIONS: 300°C MAX. FOR 5 sec.  SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE 240±3 °C FOR IMMERSION DURATION, 3 sec.  STANDARD: JIS C 60068)  RESISTANCE TO  1) PREFLOW SOLDERING:  SOLDERING HEAT  PEAK TMP: 280°CMAX  REFLOW TIMP: 220°CMIN FOR 60sec 2) SOLDERING RIONS: 300°C MAX. FOR 5 sec.  SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE 240±3 °C FOR IMMERSION DURATION, 3 sec.  STANDARD: JIS C 60068)  REMARKS: "INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.  APPROVED HS. OKAMA 11.0  CHECKED KI. HIROKAWA 11.0  DESIGNED TH. SANO 11.0  DESIGNED TH.				FREQUENCY 10 TO 55 TO 10Hz, APPROX 5min							DISCONTINUITY OF	×	+-
SHOCK				SINGLE AMPLITUDE : 0.75 mm, 10 CYCLES				1	1 μ <b>s</b> .				
AT 3 TIMES FOR 3 DIRECTIONS.  DAMP HEAT (STEADY STATE)  EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.  SIGNAL CONTACT : 100 m Ω MAX.  TEMPERATURE  SO → 30 min.  UNDER 5 CYCLES.  (RELOCATION TIME TO CHAMBER: WITHIN 2~3 MIN)  OF PARTS.  TO PARTS.  TO PARTS.  NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINAL.  TERMINAL  TERMINAL  TERMINAL  TERMINAL  SOLDERING HEAT  PEAK TMP: 280 °CMAX REFLOW TMP: 220 °CMIN FOR 60sec 2) SOLDERING IRONS: 360 °C MAX. FOR 5 sec.  SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE  240±3 °C FOR IMMERSION DURATION, 3 sec.  TERMINAL  A NEW UNIFORM COATING OF SOLDER  SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.  A NEW UNIFORM COATING OF SOLDER  SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.  THE UNIVESO PRODUCT BEFORE ASSEMBLY TO PCB.  O'THE UNIVESO PRODUCT BEFORE ASSEMBLY TO PCB.  O'THE RATED CURRENT APPLIES TO PER CONTACT.  O'THE RATED CURRENT APPLIES TO PER CONTACT.  O'THE RATED CURRENT ASSURANCE STATE  CHECKED  TH. SANO									The state of the s				-
ENVIRONMENTAL CHARACTERISTICS  DAMP HEAT (STEADY STATE)  EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.  SIGNAL CONTACT RESISTANCE: SIGNAL CONTACT : 100 m 0 MAX. MF CONTACT : 100 m 0 MAX. MF CONTACT : 40 m	SHUCI	ĸ						OF	PARTS.			×	-
DAMP HEAT (STEADY STATE)  (RECOCATION TIME 10 C HAMBER WITHIN 2~3 MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CHAMBER WITHIN 2~3 MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CHAMBER WITHIN 2~3 MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CHAMBER WITHIN 2~3 MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CHAMBER WITHIN 2~3 MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CHAMBER WITHIN 2~3 MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CHAMBER WITHIN 2~3 MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CHAMBER WITHIN 2~3 MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CHAMBER WITHIN 2~3 MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CHAMBER WITHIN 2~3 MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CABBOD MIN)  (STEADY STATE)  (RECOCATION TIME 10 C CABBOD MIN)  (STEADY STATE)  (SIGNAL CONTACT: 40 m QMAX.  (2) INSULATION CESISTANCE:  (1000 MQ MIN).  (3) NO DAMAGE, CRACK AND LOOSENESS  (F PARTS.  NO HEAVY CORROSION.  (A) NO HEAVY CORROSION.  (CEST STANDARD.  (A) NO HEAVY CORROSION.  (CEST STANDARD.  (A) NO HEAVY CORROSION.  (CEST STANDARD.  (A) NO HEAVY CORROSION.  (B) NO DEFORMATION OF CASE OF  (EXCESSIVE LOOSENESS OF THE  (EXCESSI	FN\/II	RONI	MENTAL C	1		10110.		ı					
TEMPERATURE -55 → +85 °C TIME 30 → 30 min. UNDER 5 CYCLES. (RELOCATION TIME TO CHAMBER:WITHIN 2~3 MIN)  SULFUR DIOXIDE  EXPOSED AT 25±2°C, 75±5%RH, 25 PPM FOR 96 h. (TEST STANDARD: JIS C 60068)  RESISTANCE TO 10 SOLDERING: PEAK TMP: 260°CMAX REFLOW TMP: 220°CMIN FOR 60sec 2) SOLDERING IRONS: 360°C MAX. FOR 5 sec.  SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.  SOLDERABILITY  COUNT  DESCRIPTION OF REVISIONS  DESIGNED  CHECKED  A NEW UNIFORM COATING OF 95 % OF THE SURFACE BEING IMMERSED.  A NEW UNIFORM COATING OF 95 % OF THE SURFACE BEING IMMERSED.  A PPROVED  HS. OKAWA 11. 0  CHECKED  HS. OKAWA 11. 0  CHECKED  THE NAMO 11. 0  DESIGNED  THE NATION THE SAMO THE S						5 %, 96	6 h.	① COI	NTACT RE	ESIST	TANCE:	×	Ι –
TIME 30 → 30 min. UNDER 5 CYCLES. (RELOCATION TIME TO CHAMBER:WITHIN 2~3 MIN)  SULFUR DIOXIDE  EXPOSED AT 25±2°C, 75±5%RH, 25 PPM FOR 96 h. (TEST STANDARD: JIS C 60068)  RESISTANCE TO PEAK TMP: 260°CMAX REFLOW TMP: 220°CMIN FOR 60sec 2) SOLDERING IRONS: 360°C MAX. FOR 5 sec.  SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.  COUNT  DESCRIPTION OF REVISIONS  DESIGNED  COUNT  DESCRIPTION OF REVISIONS  DESIGNED  CHECKED  APPROVED  HS. 0KAWA 11.0  DESIGNED  CHECKED  DA  CHECKED  TH. SANO  TH. SANO	<u> </u>			, ,			SIG						
UNDER 5 CYCLES.  (RELOCATION TIME TO CHAMBER WITHIN 2~3 MIN)  (RELOCATION TIME TO CHAMBER WITHIN 2~3 MIN)  (BY OP PARTS.  SULFUR DIOXIDE  EXPOSED AT 25±2°C, 75±5%RH, 25 PPM FOR 96 h.  (TEST STANDARD: JIS C 60068)  RESISTANCE TO SOLDERING HEAT  PEAK TMP : 260°CMAX REFLOW TMP: 220°CMIN FOR 60sec 2) SOLDERING IRONS: 360°C MAX. FOR 5 sec.  SOLDERING IRONS: 360°C MAX. FOR 5 sec.  SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.  REMARKS ™ INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING.  □ STORAGE* MEANS A LONG-TERM STORAGE STATE FOR THE UNUSED PRODUCT BEFORE ASSEMBLY TO PCB.  □ THE RATED CURRENT APPLIES TO PER CONTROT.  APPLY 0 4A WHEN ALL THE CONTACTS ARE USED FOR CURRENT CARRYING.  UNIESS of the WINDOW TH. SANO  UNIESS OF PARTS.  NO HEAVY CORROSION.  ★ EXCESSIVE LOOSENESS OF THE TERMINAL.  A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.  A PPROVED HS, 0KAWA  11.0  CHECKED KI. HIROKAWA 11.0  DESIGNED TH. SANO 11.0  DESIGNED TH. SANO 11.0  DESIGNED TH. SANO 11.0  DESIGNED TH. SANO TH. SANO 11.0  DRAWN TH. SANO 11.0  DRAWN TH. SANO THE TEMPERATE CONTACT. THE TEMPERAT				TEMPERATURE -55 → +85 °C							×	-	
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SULFUR DIOXIDE  EXPOSED AT 25±2°C, 75±5%RH, 25 PPM FOR 96 h. (TEST STANDARD: JIS C 60068)  RESISTANCE TO 1)REFLOW SOLDERING: PEAK TMP: 260°CMAX REFLOW TMP: 220°CMIN FOR 60sec 2) SOLDERING IRONS: 360°C MAX. FOR 5 sec.  SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.  COUNT  DESCRIPTION OF REVISIONS  DESIGNED  CHECKED  DA  REMARKS: "INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT BEFORE ASSEMBLY TO POB. G"-STORAGE MEANS A LONG-TERM STORAGE STATE FOR THE UNISED PRODUCT STATE FOR THE UNISED PRODUCT STATE TO THE MINIMUM OF 95 % OF THE TERMINAL.  A PEW UNISPORM TO THE TERM								3 NO	DAMAGE	, CR			
RESISTANCE TO (TEST STANDARD: JIS C 60068)  RESISTANCE TO SOLDERING: PEAK TMP: 220°CMIAX REFLOW TMP: 240°CMIAX				Ì.			,						
RESISTANCE TO 1)REFLOW SOLDERING: NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINAL.  PEAK TMP: 220°CMIN FOR 60sec 2) SOLDERING IRONS: 360°C MAX. FOR 5 sec.  SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec. SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.  COUNT DESCRIPTION OF REVISIONS DESIGNED CHECKED DA  REMARKS (**)INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING.  ***********************************	SULFU	JR DIO	XIDE					NO HEAVY CORROSION.				×	-
RESISTANCE TO SOLDERING: PEAK TMP: 260°CMAX REFLOW TMP: 220°CMIN FOR 60sec 2) SOLDERING IRONS: 360°C MAX. FOR 5 sec.  SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.  COUNT DESCRIPTION OF REVISIONS DESIGNED  CHECKED DA  COUNT DESCRIPTION OF REVISIONS DESIGNED  CHECKED DA  CHECKED TH. SANO 11. 0 DESIGNED TH. SANO 11. 0 DESIGNED TH. SANO TH. SANO 11. 0 DESIGNED TH. SANO TH.													
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2) SOLDERING IRONS: 360°C MAX. FOR 5 sec.  SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.  SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.  A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.  A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.  A PPROVED DA  CHECKED DA  CHECKED DA  CHECKED BING IMMERSED.  DA  CHECKED KI. HIROKAWA 11.0 CHECKED KI. HIROKAWA 11.0 CHECKED KI. HIROKAWA 11.0 DESIGNED TH. SANO 11.0 DESIG	SOLDE	ERING	HEAT										
SOLDERABILITY  SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.  SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.  COUNT  DESCRIPTION OF REVISIONS  DESIGNED  CHECKED  DA  CPUBLIC TO SECURITY STORAGE THE STORAGE STATE FOR THE UNUSED PRODUCT BEFORE ASSEMBLY TO PCB.  CPUBLIC THE RATED CURRENT APPLIES TO PER CONTACT. APPLY 0.4A WHEN ALL THE CONTACTS ARE USED FOR CURRENT CARRYING.  Unless otherwise specified, refer to JIS-C-5402.  NOTE  SPECIFICATION SHEET  PART NO.  FX18-140P-0. 8SH  HIROSE ELECTRIC CO., LTD.  CODE NO.  CL579-0007-9-00  CITY SHERM SOLDER SHALL COVER A MINIMUM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SHALL COVE	SOLDERABILITY							TERMINAL.					
SURFACE BEING IMMERSED.  COUNT DESCRIPTION OF REVISIONS DESIGNED CHECKED DA  REMARKS ON INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING.  COUNT DESCRIPTION OF REVISIONS DESIGNED CHECKED DA  REMARKS ON INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING.  COUNT DESCRIPTION OF REVISIONS DESIGNED CHECKED DA  REMARKS ON INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING.  CHECKED KI. HIROKAWA 11.0  DESIGNED TH. SANO 11.0  DESIGNED TH. SANO 11.0  DRAWN TH. SANO 11.0  DRAWN TH. SANO 11.0  REMARKS ON THE SANO THE				,				A NEW UNIFORM COATING OF SOLDER				×	+-
COUNT DESCRIPTION OF REVISIONS DESIGNED CHECKED DA  REMARKS **Include temperature rise caused by current-carrying.  **Count Description of Revisions Designed Remains a Long-term storage state For the Unused product before assembly to pcb.  **Ginter Rated current applies to per contact. Apply 0.4A When All the contacts are used for current carrying.  **Unless otherwise specified, refer to JIS-C-5402.**  **DRAWN TH. SANO 11.0  **DRAWN				240±3°C FOR IMMERSION DURATION, 3 sec.			ec.						
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